

#### N-Channel Enhancement Mode MOSFET

#### **Feature**

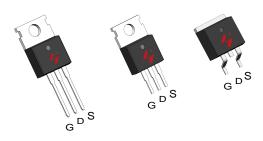
40V/90A

 $R_{DS(ON)}$ = 4.7m $\Omega$ (typ.)@V<sub>GS</sub> = 10V

 $R_{DS(ON)} = 5.7 \text{m}\Omega(\text{typ.}) @V_{GS} = 4.5 \text{V}$ 

- 100% Avalanche Tested
- Reliable and Rugged
- Lead Free and Green Devices Available (RoHS Compliant)

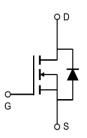
## **Pin Description**



TO-220FB-3L TO-220FB-3S TO-263-2L

## **Applications**

- Switching application
- Power Management for Inverter Systems



N-Channel MOSFET

## **Ordering and Marking Information**



Package Code

P:TO-220FB-3L B:TO-263-2L

M:TO-220FB-3S

Date Code Assembly Material

YYXXX WW G:Lead Free

Note: HUAYI lead-free products contain molding compounds/die attach materials and 100% matte tin plate Termi-Nation finish; which are fully compliant with RoHS. HUAYI lead-free products meet or exceed the lead-Free requirements of IPC/JEDEC J-STD-020 for MSL classification at lead-free peak reflow temperature. HUAYI defines "Green" to mean lead-free (RoHS compliant) and halogen free (Br or Cl does not exceed 900ppm by weight in homogeneous material and total of Br and Cl does not exceed 1500ppm by weight).

HUAYI reserves the right to make changes, corrections, enhancements, modifications, and improvements to this product and/or to this document at any time without notice.



# **Absolute Maximum Ratings**

Symbol	Parameter	Rating	Unit	
Common Rat	tings (Tc=25°C Unless Otherwise Noted)		•	
VDSS	Drain-Source Voltage		40	V
Vgss	Gate-Source Voltage		±25	V
TJ	Junction Temperature Range		-55 to 175	°C
Tstg	Storage Temperature Range		-55 to 175	°C
ls	Source Current-Continuous(Body Diode)	Tc=25°C	90	Α
Mounted on	Large Heat Sink	,		1
lом	Pulsed Drain Current *	Tc=25°C	324	А
	Continuous Danis Compant	Tc=25°C	90	А
lσ	Continuous Drain Current	Tc=100°C	62	А
	M	Tc=25°C	100	W
Po	Maximum Power Dissipation Tc=100°C		50	W
R₀uc	Thermal Resistance, Junction-to-Case**		1.5	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient		62.5	°C/W
Eas	SinglePulsed-Avalanche Energy ***	L=0.3mH	184	mJ

Note: \* Repetitive rating; pulse width limited by max.junction temperature. Drain

\*\* current is limited by junction temperature

\*\*\* Limited by TJmax, starting TJ=25°C, L = 0.3mH, VD= 32V, VGs =10V.

# **Electrical Characteristics**(Tc =25°C Unless Otherwise Noted)

Cumbal	Parameter	Toot Co.	n dition o	HY1904			Unit
Symbol	Faranietei	Test Conditions		Min	Тур.	Max	Offic
Static Char	Static Characteristics						
BVDSS	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V,I <sub>DS</sub> =2	250µA	40	-	-	V
Ipss	Drain to Source Leakage Current	V <sub>DS</sub> =40V,V <sub>GS</sub>	S=0V	-	-	1	μA
IDSS	Drain-to-Source Leakage Current		TJ=125°C	-	-	100	μA
V <sub>GS(th)</sub>	Gate Threshold Voltage	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>DS</sub>	=250µA	1.0	1.7	3.0	V
Igss	Gate-Source Leakage Current	$V_{GS}=\pm 25V, V_{DS}=0V$		ı	-	±100	nA
RDS(ON)*	Drain-Source On-State Resistance	V <sub>GS</sub> =10V,I <sub>DS</sub> =45A		ı	4.7	6.0	mΩ
RDS(ON)*	Drain-Source On-State Resistance	V <sub>GS</sub> =4.5V,I <sub>DS</sub> =45A		-	5.7	7.0	mΩ
Diode Char	Diode Characteristics						
V <sub>SD</sub> *	Diode Forward Voltage	I <sub>SD</sub> =45A,V <sub>GS</sub> =0V		-	0.8	1.0	V
trr	Reverse Recovery Time	lon=45 A dlon/dt=100 A /u.o.		-	25	-	ns
Qrr	Reverse Recovery Charge	- IsD=45A,dIsD/dt=100A/μs		-	16	-	nC

# HY1904P/B/M



# Electrical Characteristics (Cont.) (Tc =25°C Unless Otherwise Noted)

Comple al	Barrantan	HY1904		HY1904		l lnit
Symbol	Parameter	Test Conditions	Min	Тур.	Max	Unit
Dynamic (	Characteristics					
Rg	Gate Resistance	V <sub>GS</sub> =0V,V <sub>DS</sub> =0V,F=1MHz	-	1.6	-	Ω
Ciss	Input Capacitance	V <sub>GS</sub> =0V,	-	2274	-	
Coss	Output Capacitance	V <sub>DS</sub> =25V,	-	194	-	pF
Crss	Reverse Transfer Capacitance	Frequency=1.0MHz	-	70	-	ľ
<b>t</b> d(ON)	Turn-on Delay Time		-	8	-	
Tr	Turn-on Rise Time	$V_{DD}$ =20 $V$ , $R_{G}$ =6 $\Omega$ ,	-	40	-	no
td(OFF)	Turn-off Delay Time	Ips=45A,Vgs=10V	-	29	-	ns
Tf	Turn-off Fall Time		-	20	-	
Gate Char	Gate Charge Characteristics					
Qg	Total Gate Charge	\/ -32\/ \/ -10\/	-	52	-	
Qgs	Gate-Source Charge	$V_{DS} = 32V, V_{GS} = 10V,$ $I_{D} = 45A$	-	6	-	nC
Qgd	Gate-Drain Charge		-	11	-	

Note: \*Pulse test, pulse width  $\leq 300$ us, duty cycle  $\leq 2\%$ 



# **Typical Operating Characteristics**

**Figure 1: Power Dissipation** 

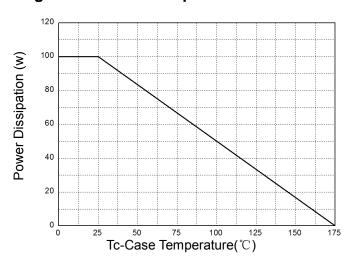
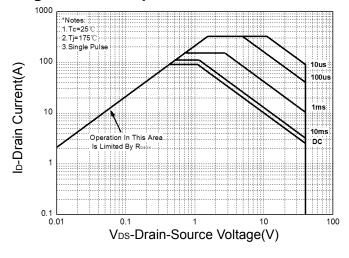


Figure 3: Safe Operation Area



**Figure 5: Output Characteristics** 

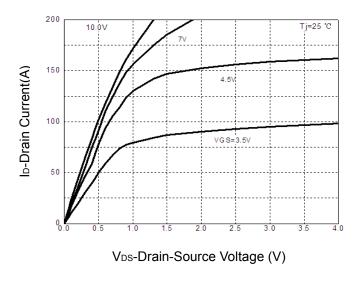


Figure 2: Drain Current

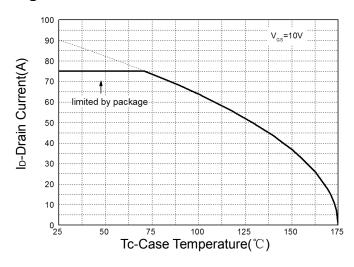


Figure 4: Thermal Transient Impedance

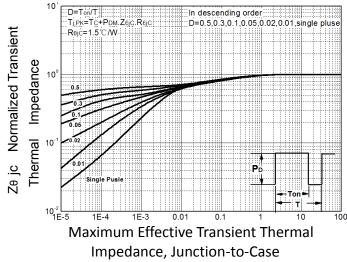
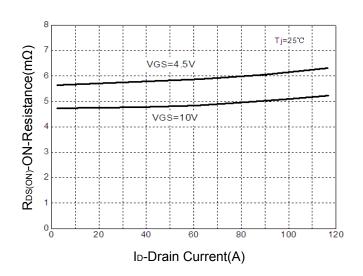


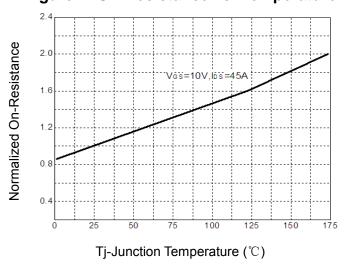
Figure 6: Drain-Source On Resistance





## **Typical Operating Characteristics(Cont.)**

Figure 7: On-Resistance vs. Temperature



**Figure 9: Capacitance Characteristics** 

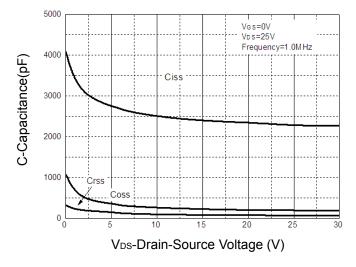


Figure 8: Source-Drain Diode Forward

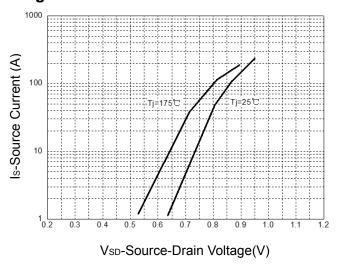
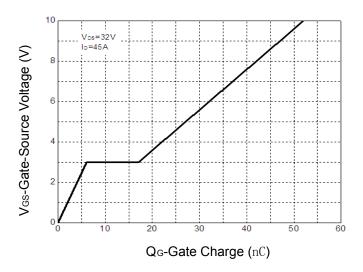
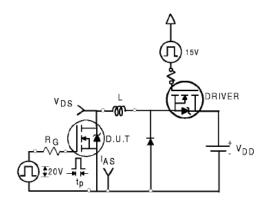


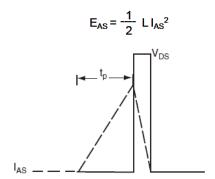
Figure 10: Gate Charge Characteristics



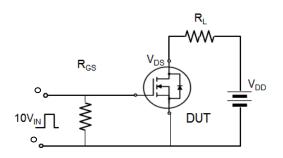


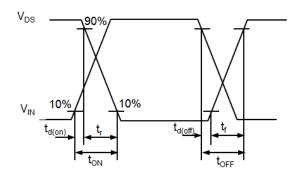
# **Avalanche Test Circuit**



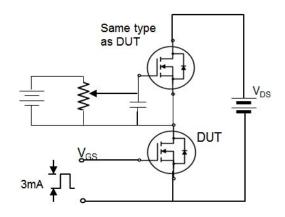


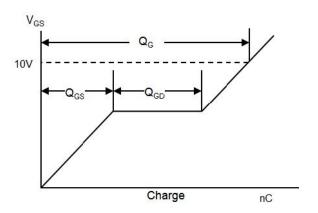
# **Switching Time Test Circuit**





# **Gate Charge Test Circuit**





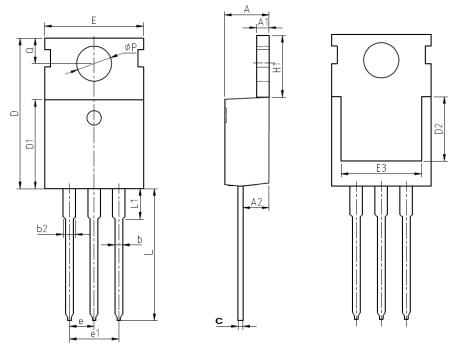


# **Device Per Unit**

Package Type	Unit	Quantity
TO-220FB-3L	Tube	50
TO-263-2L	Tube	50
TO-220FB-3S	Tube	50

# Package Information

## TO-220FB-3L

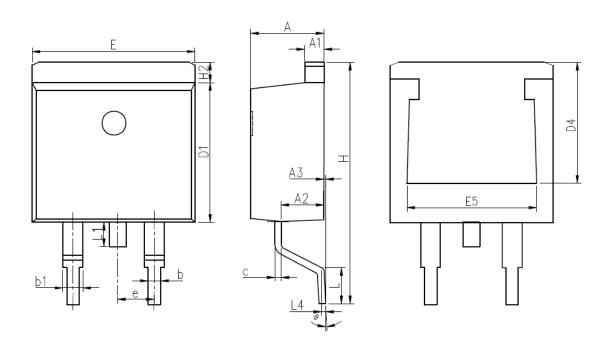


### **COMMON DIMENSIONS**

CVMDOL		mm	
SYMBOL	MIN	NOM	MAX
А	4.37	4.57	4.77
A1	1.25	1.30	1.45
A2	2.20	2.40	2.60
b	0.70	0.80	0.95
b2	1.17	1.27	1.47
С	0.40	0.50	0.65
D	15.10	15.60	16.10
D1	8.80	9.10	9.40
D2	5.50	-	-
E	9.70	10.00	10.30
E3	7.00	-	-
е		2.54 BSC	
e1		5.08 BSC	
H1	6.25	6.50	6.85
L	12.75	13.50	13.80
L1	-	3.10	3.40
ФР	3.40	3.60	3.80
Q	2.60	2.80	3.00



### TO-263-2L

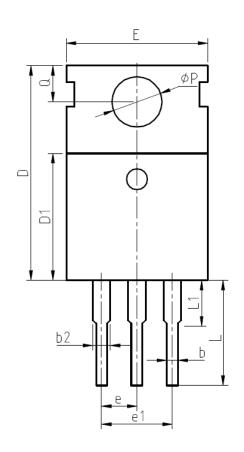


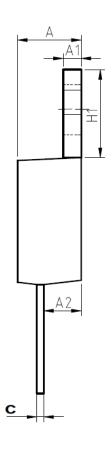
### **COMMON DIMENSIONS**

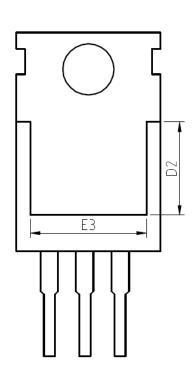
SYMBOL		mm	
STWIDOL	MIN	NOM	MAX
Α	4.37	4.57	4.77
A1	1.22	1.27	1.42
A2	2.49	2.69	2.89
A3	0	0.13	0.25
b	0.7	0.81	0.96
b1	1.17	1.27	1.47
С	0.3	0.38	0.53
D1	8.5	8.7	8.9
D4	6.6	-	-
Е	9.86	10.16	10.36
E5	7.06	-	-
е		2.54 BSC	;
Н	14.7	15.1	15.5
H2	1.07	1.27	1.47
L	2	2.3	2.6
L1	1.4	1.55	1.7
L4	0.25 BSC		
θ	0°	5°	9°



### TO-220FB-3S







### COMMON DIMENSIONS

SYMBOL		mm	
STIVIBUL	MIN	NOM	MAX
А	4.37	4.57	4.77
A1	1.25	1.30	1.45
A2	2.20	2.40	2.60
b	0.70	0.80	0.95
b2	1.17	1.27	1.47
С	0.40	0.50	0.65
D	15.10	15.60	16.10
D1	8.10	9.10	9.40
D2	5.50	-	-
E	9.70	10.00	10.30
E3	7.00	-	ı
е		2.54 BSC	
e1		5.08 BSC	
H1	6.25	6.50	6.85
L	6.80	7.00	7.20
L1	-	3.10	3.40
ФР	3.40	3.60	3.80
Q	2.60	2.80	3.00



## **Classification Profile**



## **Classification Reflow Profiles**

Sn-Pb Eutectic Assembly	Pb-Free Assembly
100 °C 150 °C 60-120 seconds	150 °C 200 °C 60-120 seconds
3 °C/second max.	3°C/second max.
183 °C 60-150 seconds	217 °C 60-150 seconds
See Classification Temp in table 1	SeeClassification Tempin table 2
20** seconds	30** seconds
6 °C/second max.	6 °C/second max.
6 minutes max.	8 minutes max.
	100 °C 150 °C 60-120 seconds  3 °C/second max.  183 °C 60-150 seconds  See Classification Temp in table 1  20** seconds  6 °C/second max.

<sup>\*</sup>Tolerance for peak profile Temperature (Tp) is defined as a supplier minimum and a user maximum.

<sup>\*\*</sup> Tolerance for time at peak profile temperature (tp) is defined as a supplier minimum and a user maximum.

## HY1904P/B/M



Table 1.SnPb Eutectic Process – Classification Temperatures (Tc)

Package Thickness	Volume mm³ <350	Volume mm³ ≥350
<2.5 mm	235 °C	220 °C
≥2.5 mm	220 °C	220 °C

#### Table 2.Pb-free Process – Classification Temperatures (Tc)

Package	Volume mm³	Volume mm³	Volume mm³
Thickness	<350	350-2000	≥2000
<1.6 mm	260 °C	260 °C	260 °C
1.6 mm – 2.5 mm	260 °C	250 °C	245 °C
≥2.5 mm	250 °C	245 °C	245 °C

# **Reliability Test Program**

Test item	Method	Description
SOLDERABILITY	JESD-22, B102	5 Sec, 245°C
HTRB	JESD-22, A108	168 Hrs/500 Hrs/1000 Hrs, Bias@150°C
PCT	JESD-22, A102	96 Hrs, 100%RH, 2atm, 121°C
TCT	JESD-22, A104	500 Cycles, -55°C~150°C

#### **Customer Service**

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